

February 18, 2004

Commissioner for Patents P.O.Box 1450 Alexandria, VA 22313-1450

Fr: George O. Saile, Reg. No. 19,572 28 Davis Avenue Poughkeepsie, N.Y. 12603

Subject:

| Serial No. 10/734,423 12/12/03 |

Zhang Fan et al.

A NEW DESIGN AND METHOD OF FABRICATION OF A DIE OXIDE RING

INFORMATION DISCLOSURE STATEMENT

Enclosed is Form PTO-1449, Information Disclosure Citation In An Application.

The following Patents and/or Publications are submitted to comply with the duty of disclosure under CFR 1.97-1.99 and 37 CFR 1.56.

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on February 23, 2004.

Stephen B. Ackerman, Reg.# 37761

Signature/Date Sps Chu 2/23/01

CS-03-026

- U.S. Patent 5,776,826 to Mitwalsky et al., "Crack Stop Formation for High-Productivity Processes," describes a fuse etch to form a crack stop to prevent cracks from propagating during dicing.
- U.S. Patent 6,509,622 to Ma et al., "Integrated Circuit Guard Ring Structures, " discloses a plurality of metal guard rings to prevent cracks.
- U.S. Patent 6,596,562 to Maiz, "Semiconductor Wafer Singulation Method," teaches using a laser gun to form trenches between guard rings to isolate the saw from the integrated circuits.
- U.S. Patent 6,107,161 to Kitaguro et al., "Semiconductor Chip and a Method for Manufacturing Thereof," discloses forming cutting grooves outside of the guard ring to prevent cracking during dicing.

Sincerely,

Stephen B. Ackerman,

Reg. No. 37761

Form PTO-1449 INFORMATION DISCLOSURE CITATION IN AN APPLICATION (Uso soveral shouts if necessary) U. S'. PATENT DOCUMENTS REMINAR DOCUMENT NUMBER DATE KULE CLUE ACMO DYLE NUSCULE 438 257 438 438 FOREIGN PATENT DOCUMENTS Translation DOCUMENT NUMBER OUTE cuss COUNTRY SUBCLASS YES OTHER DOCUMENTS (Including Author, Title, Dalo, Portliner Pages, Elc.) EXAMMER DATE CONKDERED

EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP § 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to the applicant.